Junction FETs

Unit: mm

DSK9J01×0L

# **Panasonic**

### DSK9J01×0L

#### Silicon N-channel Junciton FET

For low frequency amplification / For pyroelctric sensor DSK5J01 in SSMini3 type package

#### ■ Features

- · High gate-drain Voltage(Source open)VGDO
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)

■ Marking Symbol: B6

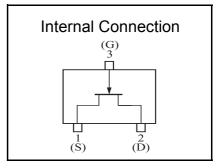
#### Packaging

Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)

1.6

■ Absolute Maximum Ratings Ta = 25 °C

Parameter	Symbol	Rating	Unit
Gate-drain voltage (Source short)	VGDS	-55	V
Drain current	ID	30	mA
Gate current	IG	10	mA
Power dissipation	PD	125	mW
Channel temperature	Tch	150	°C
Operating ambient temperature	Topr	-40 to +85	°C
Storage temperature	Tstg	-55 to +150	°C



#### ■ Electrical Characteristics Ta = 25 °C ± 3 °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit		
Gate-drain voltage (Source short)	VGDS	IG = -100 μA, VDS = 0	-55			V		
Drain current *1	IDSS	VDS = 10 V , VGS = 0	1.0		6.5	mA		
Gate-source cutoff current	IGSS	VGS = -30 V, VDS = 0			-10	nA		
Gate-source cutoff voltage	VGSC	VDS = 10 V, ID = 10 μA			-5	V		
Forward transfer admittance	Yfs	VDS = 10 V, ID = 5 mA, f =1 kHz	2.5	7.5		mS		
Small-signal short-circuit input capacitance	Ciss	VDS = 10 V, VGS = 0, f = 1 MHz		6.0		pF		
Small-signal reverse transfer capacitance	Crss	VD3 - 10 V, VG3 - 0, 1 - 1 WINZ		2.5		pF		

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 Measuring methods for transistors.

#### \*1 Rank classification

Established: 2010-09-07

: 2014-03-25

Revised

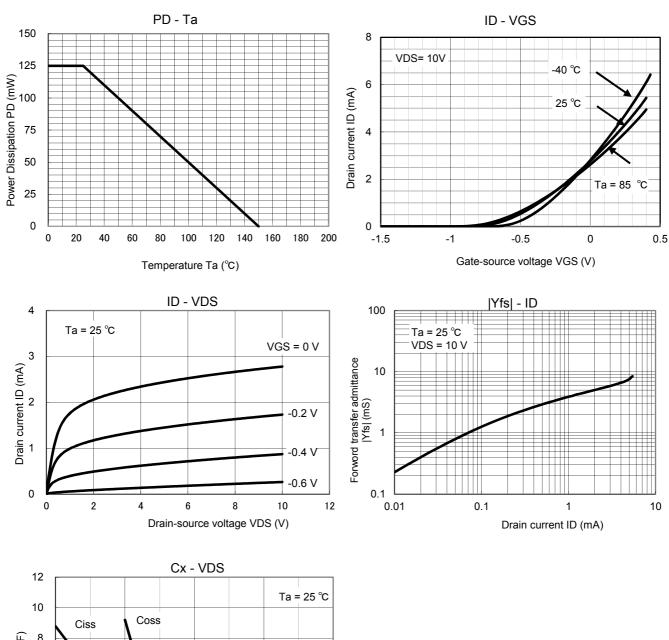
Code	Р			Q			
Rank	Р			Q			
IDSS (mA)	1.0	to	3.0	2.0	to	6.5	
Marking symbol	B6P		B6Q				
							_

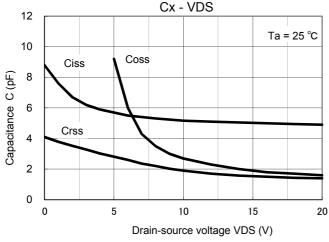
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### Technical Data (reference)





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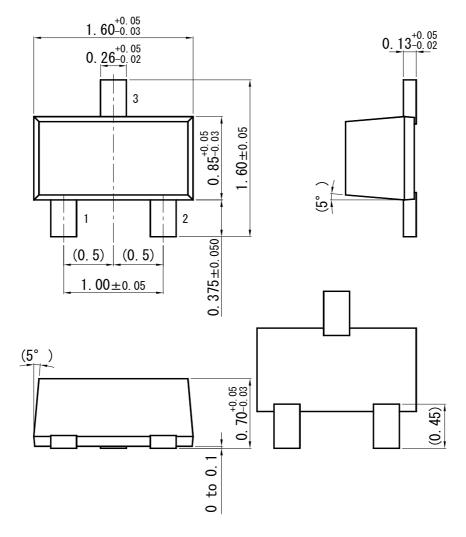
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DSK9J01×0L

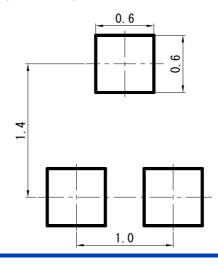
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SSMini3-F3-B

Unit: mm



■ Land Pattern (Reference) (Unit: mm)



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Established: 2010-09-07 Revised: 2014-03-25

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